



User's Guide

NHD-320240WX-COTFH-V#I041 LCM

(Liquid Crystal Display Graphic Module) RoHS Compliant

NHD- Newhaven Display **320240-** 320 x 240 Dots

WX- W= V ersion Line X=Display Type- Tab Type

C O - Model/ Serial Number T- White LED B/L

F- FSTN (+)

H- Transflective, 6:00 View, Wide Temperature (-20 \sim +70c)

V#- With Built in Positive Voltage, #: RoHS Compliant

IO41- I: ICIST3031TA0# ICIST3032TA0# ; 04Sales code 1: Version

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VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2008/5/10		First issue

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1. Module Classification Information

① Brand: Newhaven Display

② Display Font: 320 * 240 Dots

3 Factory Line: W

4 Display Type: H \rightarrow Character Type, G \rightarrow Graphic Type, C \rightarrow Color, X \rightarrow Tab Type

⑤ Model / Serial number: C0 → With RA8835 Controller

© Backlight Type: N→Without backlight T→White LED

 $B \rightarrow EL$, Blue green $A \rightarrow LED$, Amber $D \rightarrow EL$, Green $R \rightarrow LED$, Red $W \rightarrow EL$, White $O \rightarrow LED$, Orange $F \rightarrow CCFL$, White $G \rightarrow LED$, Green

Y→LED, Yellow Green

⑦ LCD Mode : B→TN Positive, Gray
T→FSTN Negative

N→TN Negative, Y→STN Positive, Yellow Green

G→STN Positive, Gray M→STN Negative, Blue

F→FSTN Positive

Temperature range/ D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00 View direction G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00

J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00
B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00
E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

9 Special Code #: RoHS; V: Built in Positive Voltage;

I: ICIST3031TA0# ICIST3032TA0

04: Sales Code 1: Version(Frame have screw hold; CN=22PIN Down connect)

2. Precautions in Use of LCD Module

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD Module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components
- (9) Winstar have the right to change the PCB Rev.

3. General Specification

ITEM	STANDARD VALUE	UNIT		
Number of dots	320x240	dots		
Outline dimension	94.7(W)x 83.3(H)x 8.6max(T)	mm		
View area	81.4(W) x 61.0(H)	mm		
Active area	76.78(W)x 57.58(H)	mm		
Dot size	0.225(W)x 0.225(H)	mm		
Dot pitch	0.24(W)x 0.24(H)	mm		
LCD type	FSTN Positive Transflective,			
	(In LCD production, It will occur slightly color difference. We can			
	only guarantee the same color in the same batch.)			
View direction	6 o'clock			
Backlight	LED, White			

4.Absolute Maximum Ratings

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
Operating Temperature	T_{OP}	-20	_	+70	$^{\circ}\mathbb{C}$
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\mathbb{C}$
Input Voltage	V _I	0	_	$V_{ m DD}$	V
Supply Voltage For Logic	$V_{ m DD}$	0	_	3.5	V
Supply Voltage For LCD	Vo-V _{SS}	0	_	30	V
DC-DC converter output	VEE			23	

5. Electrical Characteristics

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Logic Voltage	V_{DD} - V_{SS}	_	3.0	3.3	3.6	V
		Ta= -20°C	_	_	22.5	V
Supply Voltage For	Vo-V _{SS}	Ta=25°C	_	18.7	_	V
LCD		Ta=+70°C	12.2	_	_	V
Input High Volt.	V_{IH}	_	$0.5V_{DD}$	_	$V_{ m DD}$	V
Input Low Volt.	V_{IL}	_	V_{SS}		$0.2V_{DD}$	V
Output High Volt.	V_{OH}	_	2.4	_	_	V
Output Low Volt.	V _{OL}	_	_	_	0.4	V
Supply Current	I_{DD}	_	20.0	30.0	50.0	mA

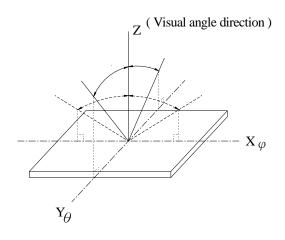
6. Optical Characteristics

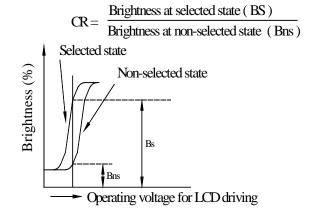
ITEM	SYMBAL	CONDITION	MIN	TYP	MAX	UNIT
7.7. A 1	(V) θ	CR≧2	30	_	60	deg.
View Angle	(H) φ	CR≧2	-45	_	45	deg.
Contrast Ratio	CR	_		5	_	_
Response Time	T rise	_	_	200	300	ms
	T fall	_	_	150	200	ms

6.1 Definitions

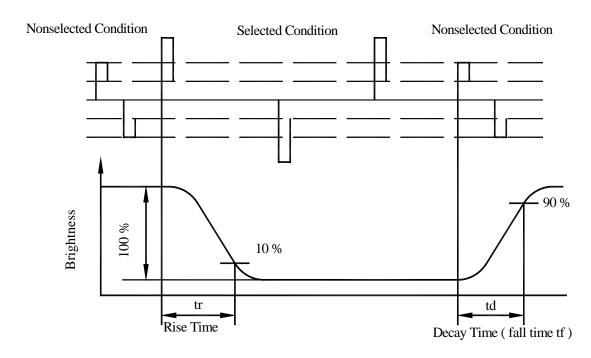
■View Angles

Contrast Ratio

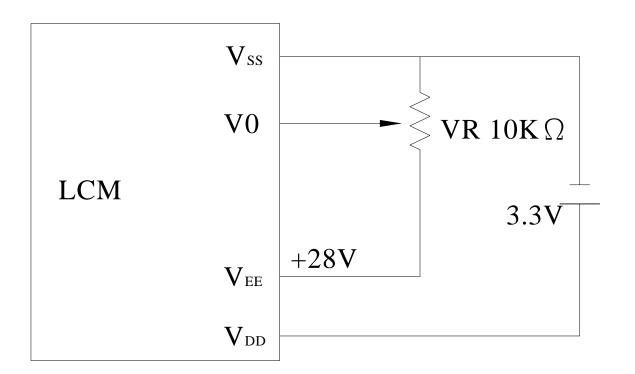




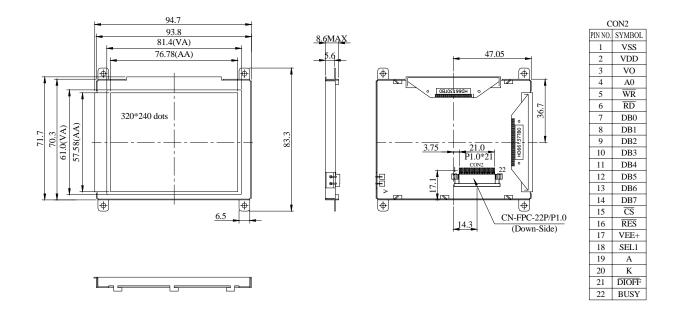
Response time

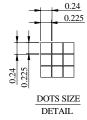


7. Power Supply for LCD Module

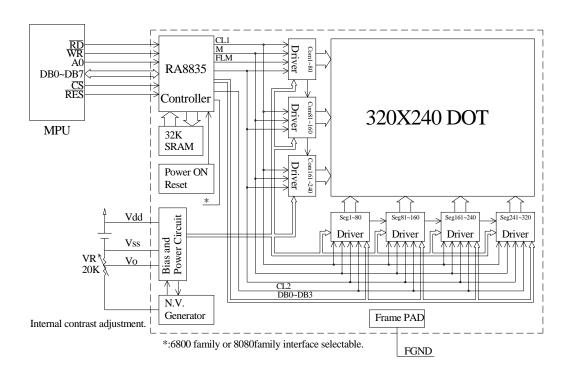


8. Contour Drawing & Block diagram





The non-specified tolerance of dimension is 10.2mm .



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9. Interface Pin Function

Pin No.	Symbol	Level	Description
1	V_{SS}		Ground
2	V_{DD}		Power supply for Logic
3	V_{O}	(Variable)	Operation voltage LCD driving
4	A_0	H/L	H:Data L:Instruction
5	$\overline{\mathrm{WR}}$	Н	8080 family: Write signal, 6800 family: Enable clock
6	$\overline{\text{RD}}$	L	8080 family: Read signal, 6800 family: R/W signal
7	DB0	H/L	DB0 Data bus line
8	DB1	Н	DB1 Data bus line
9	DB2	H/L	DB2 Data bus line
10	DB3	H/L	DB3 Data bus line
11	DB4	H/L	DB4 Data bus line
12	DB5	Н	DB5 Data bus line
13	DB6	H/L	DB6 Data bus line
14	DB7	H/L	DB7 Data bus line
15	CS	H/L	Chip Enable
16	RES	H/L	Reset
17	VEE		Positive voltage output
18	SEL1	H/L	8080 OR 6800 Family Interface Select; H:68xx, L:80xx
19	A		Power supply for B/L
20	K		Power supply for B/L
21	DIOFF		DISPOFF
22	BUSY		BUSY

10. Timing Characteristics

PLEASE TO CONSULT RA8835 SPEC

11.RELIABILITY

Content of Reliability Test (wide temperature, -20°c~70°C)

	Environmental Test		
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5k Ω CS=100pF 1 time	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: Vibration test will be conducted to the product itself without putting it in a container.

12. Backlight Information

Specification

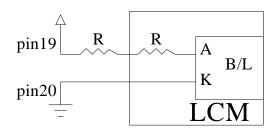
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	100	120	180	mA	V=3.5V
Supply Voltage	V	3.4	3.5	3.6	V	
Reverse Voltage	VR	_	_	5	V	
Luminous Intensity	IV	160	200	_	CD/M2	ILED=120mA
Life Time		_	10K	_	Hr.	ILED≦120mA
(For Reference only)						25°C,50-60%RH, (Note 1)
Color	white					

Note: The LED of B/L is drive by current only, drive voltage is for reference only.

drive voltage can make driving current under safety area (current between minimum and maximum)

Note 1:The brightness will decrease to 50% of the original value after 10K hours

Drive from pin19,pin20



13. Inspection specification

NO	Item	Criterion	AQL		
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 	0.65		
02	Black or white spots on LCD (display only)	 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm 			
03	LCD black spots, white spots, contaminati on (non-display	3.1 Round type : As following drawing $\Phi = (x + y) / 2$ X Y $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$ 3.2 Line type : (As following drawing) $Length Width Accept able Q TY$ $W \le 0.02 Accept no dense$ $L \le 3.0 0.02 < W \le 0.03$ $L \le 2.5 0.03 < W \le 0.05$ $ 0.05 < W$ As round type	2.5		
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction. $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	2.5		

NO	Item	Criterion	AQL
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination	
06	Chipped glass	Symbols Define: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length: 6.1.1 Chip on panel surface and crack between panels:	2.5

NO	Item	Criterion	AOL	

06	Glass crack	L: Electrode pad length 6.2 Protrusion over terminal: 6.2.1 Chip on electrode pad: y: Chip width x: Chip length y≤0.5mm x≤1/8a 6.2.2 Non-conductive portion: y: Chip width x: Chip length y≤ L x≤1/8a ⊙ If the chipped area touches the ITO term must remain and be inspected according specifications. ⊙ If the product will be heat sealed by the mark not be damaged. 6.2.3 Substrate protuberance and internal crack. y: width y≤1/3L		
NO	Item	Criterion	AOL	

l	NO	Item	Criterion	AQL	
					_

07	Cracked glass	The LCD with extensive crack is not acceptable.				
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 				
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.				
10	PCB、COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB 				
11	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxid icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.		2.5 2.5 2.5 0.65			

NO	Item Criterion				
12	General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 LCD pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. 	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65 0.65		

14. Material List of Components for RoHs

1. Newhaven Display International hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs	
Limited	100	1000	1000	1000	1000	1000	
Value ppm ppm ppm ppm ppm							
Above limited value is set up according to RoHS.							

2.Process for RoHS requirement:

(1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.

(2) Heat-resistance temp. :

Reflow: 250° C, 30 seconds Max.;

Connector soldering wave or hand soldering : 320° C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. $: 235\pm5^{\circ}\mathbb{C}$;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

Newhaven

LCM Sample Estimate Feedback Sheet

Aodule Nu						Page: 1
	Specification :					
1. Par	nel Type:		Pass		NG	,
2. Vie	ew Direction:		Pass		NG	,
3. Nu	mbers of Dots:		Pass		NG	,
4. Vie	ew Area:		Pass		NG	,
5. Ac	tive Area:		Pass		NG	,
6. Op	erating Temperature:		Pass		NG	,
7. Sto	rage Temperature:		Pass		NG	,
8. Oth	ners:					
2 · <u>Mecha</u>	nical Specification:					
1. PC	B Size:		Pass		NG	,
2. Fra	me Size:		Pass		NG	,
3. Ma	teral of Frame:		Pass		NG	,
4. Co	nnector Position:		Pass		NG	,
5. Fix	Hole Position:		Pass		NG	,
6. Bac	cklight Position:		Pass		NG	,
7. Thi	ickness of PCB:		Pass		NG	,
8. He	ight of Frame to PCB:		Pass		NG	,
9. He	ight of Module:		Pass		NG	,
10. Oth	ners:		Pass		NG	,
3 \ <u>Relativ</u>	re Hole Size :					
1. Pito	ch of Connector:		Pass		NG,	,
2. Hol	e size of Connector:		Pass		NG,	,
3. Mo	unting Hole size:		Pass		NG,	,
4. Mo	unting Hole Type:		Pass		NG,	<u>, </u>
5. Oth	ers:		Pass		NG,	,
\ <u>Backlig</u>	tht Specification:					
1. B/L	Type:		Pass		NG,	
2. B/L	Color:		Pass		NG,	
3. B/L	Driving Voltage (Refer	ence	for LE	D Type)	I	Pass NG,
4. B/L	Driving Current:		Pass		NG,	
5. Brig	htness of B/L:		Pass		NG,	
6. B/L	Solder Method:		Pass		NG,	
7. Othe	ers:		Pass			
		>	> Go	to page 2	<<	
NI	vhovon					
	whaven					
dule Numl	oer :					Page: 2

5 · Electronic Characteristics of Module :							
1.	Input Voltage:	Pass	□ NG ,				
2.	Supply Current:	Pass	□ NG ,				
3.	Driving Voltage for LCD:	Pass	□ NG ,				
4.	Contrast for LCD:	Pass	□ NG ,				
5.	B/L Driving Method:	Pass	□ NG ,				
6.	Negative Voltage Output:	Pass	□ NG ,				
7.	Interface Function:	Pass	□ NG ,				
8.	LCD Uniformity:	Pass	□ NG ,				
9.	ESD test:	Pass	□ NG ,				
10.	Others:	Pass	□ NG ,				
6 .	Summary:						
	Sales signature:		_				

Date: / /

Customer Signature :